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Patent Application No. 10/812,734  
Customer Number: 42717

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Shau-Lin Shue, et al.	§	Docket No.:	24061.587
		§		(TSMC2000-0101)
Serial No.:	10/812,734	§		
Filing Date:	March 30, 2004	§	Examiner:	Bradley Smith
		§	Art Unit:	2824
For:	Method for Forming a Self-	§	Conf. No.:	4809
	Passivated Copper Interconnect	§		
	Structure	§		

**RESPONSE TO RESTRICTION REQUIREMENT**

Mail Stop: Amendment  
Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed August 31, 2004, applicant hereby elects, Group II, Claims 32-56, which is drawn to a device.

Applicant's election is made with traverse on the grounds that the embodiments delineated by the examiner are not patentably distinct and therefore constitute a single invention concept.

An early action on the merits is respectfully requested.

Respectfully submitted,

David M. O'Dell  
Reg. No. 42,044

Date: 9-30-04

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop: Amendment, Commissioner For Patents, PO Box 1450, Alexandria, VA 22313-1450 on the date below.

Bonnie Boyle  
Name

9-30-04  
Date